Oh:5 No. 0651-0011 (exp. 4/94) 7-23-99  Tab settings □ □ ▼	T U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office 5798X00  ▼ ▼  iginal documents or copy thereof.					
1. Name of conveying party(ies): Mitsuo Usami Kunihiro Tsubosaki Masaru Miyazaki Additional name(s) of conveying party(ies) attached? □ Yes	2. Name and address of receiving party(ies)  Name: Hitachi, Ltd.  Internal Address:					
3. Nature of conveyance:						
Assignment   Merger	Street Address: 6, Kanda Surugadai 4-chome					
☐ Security Agreement ☐ Change of Name ☐ Other	Chiyoda-ku  City:Tokyo 100 JAPAN State:ZIP:					
Execution Date:	Additional name(s) & address(es) attached?   Yes No					
If this document is being filed together with a new application  A. Patent Application No.(s)	B. Patent No.(s)					
Additional numbers attached?   Yes No						
<ol><li>Name and address of party to whom correspondence concerning document should be mailed:</li></ol>	6. Total number of applications and patents involved: 1					
Name: Gregory E. Montone, Esq.  Internal Address: ANTONELLI, TERRY, STOUT  & KRAUS, LLP	7. Total fee (37 CFR 3.41)\$\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\					
Street Address: 1300 N. Seventeenth Street  Suite 1800  City: Arlington State: VA ZIP: 22209	8. Deposit account number:  01-2135  (Attach duplicate copy of this page if paying by deposit account)					
01 FC:581  9. Statement and signature.  To the best of my knowledge and belief, the foregoing informathe original document.  Gregory E. Montone	THIS SPACE  ation is true and correct and any attached copy is a true copy of  July 23, 1999					
	Signature Date Date poer sheet, attachments, and document:					

## **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to SEMICONDUCTOR DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

Signed on the date(s) indicated aside signatures :

	INVENTOR(S) (発明者フルネームサイン)	Date Signed <b>(</b> 署名日)		Witnesses (立会人サイン)	
1)	Mitsuo Usami Mitsuo Usami	December	1, 1997	/digoshi /digoshi Toshibazu	Kawai
2)	Kunihiro Tsubosaki Kunihiro Tsubosaki	December	1, 1997	/Liposhi	Kawai
3)	Masaru Miyazaki Masaru Miyazaki	December	1, 1997	Toshikazu	Fichasawa
4)_	<del>-</del>				
5)_					
6) _					
7)					
8) _					
9) _					
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